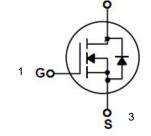


#### **Features**

- 12A, 670V, RDS(on) =  $0.615\Omega$  @VGS = 10 V
- Low gate charge (typical 26 nC)
- Low Crss (typical 4.4pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability





#### **General Description**

This Power MOSFET is produced by WPM using its own advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Symbol	Parameter	Value	Units
VDSS	Drain-Source Voltage	670	V
I <sub>D</sub>	Drain Current - Continuous (TC= 25°C) - Continuous (TC= 100°C)	12	Α
		6.7*	А
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	48*	Α
V <sub>GSS</sub>	Gate-Source Voltage	± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	490	mJ
I <sub>AR</sub>	Avalanche Current (Note 1)	12	Α
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	40	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5	V/ns
$P_D$	Power Dissipation (TC = 25°C) - Derate above 25°C	27.8	W
		0.23	W/°C
T <sub>j</sub> ,T <sub>stg</sub>	Operating and Storage Temperature Range	-55 to +150	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes,1/8" from case for 5 seconds	300	°C

2

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	4.48	°C/W
$R_{ heta JS}$	Thermal Resistance, Case-to-Sink Typ.		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	37.0	°C/W

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<sup>\*</sup> Drain current limited by maximum junction temperature



# Electrical Characteristics TC = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics			•		
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	670			V
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenc ed to 25°C		0.62		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 670 V, V <sub>GS</sub> = 0 V			1	μA
		V <sub>DS</sub> = 536 V, TC = 125°			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
On Chara	acteristics					
$V_{GS(TH)}$	Gate Threshold voltage	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	2.0		4.0	V
R <sub>DS(On)</sub>	Drain-Source on-state resistance	$V_{GS}$ =10 V, $I_{D}$ = 6 A, $T_{J}$ = 25°C		0.615	0.760	Ω
g <sub>FS</sub>	Forward Transconductance	$T_J = 25^{\circ}C$ $V_{DS} = 40 \text{ V}, I_D = 6 \text{ A}$ (Note 4)		12		S
Dynamic	Characteristics					
$C_{iss}$	Input capacitance	.,		1183		pF
$C_{oss}$	Output capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		172		pF
$C_{rss}$	Reverse transfer capacitance			4.4		pF
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn On Delay Time			15		ns
t <sub>r</sub>	Rising Time	$V_{DD}$ = 335 V, ID = 12 A, R <sub>G</sub> = 25 $\Omega$ (Note 4, 5)		30		ns
$t_{\text{d(off)}}$	Turn Off Delay Time			63		ns
t <sub>f</sub>	Fall Time			36		ns
$Q_g$	Total Gate Charge	- V <sub>DS</sub> = 536 V, ID = 12 A, V <sub>GS</sub> = 10 V - (Note 4, 5)		26		nC
$Q_{gs}$	Gate-Source Charge			5.6		nC
$Q_{gd}$	Gate-Drain Charge			10		nC
	urce Diode Characteristics and	Maximum Ratings		-		
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				12	А
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				48	A
$V_{SD}$	Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12 A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12 A,		389		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> / dt = 100 A/μs Note 4)		3.4		μC

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 9.6 mH, IAS = 12 A, VDD = 50V, RG = 25  $\Omega$ , Starting TJ = 25  $^{\circ}$ C
- 3. ISD $\le$ 12A, di/dt  $\le$ 200A/us, VDD  $\le$  BVDSS, Starting TJ = 25°C 4. Pulse Test : Pulse width  $\le$  300us, Duty cycle  $\le$  2%
- 5. Essentially independent of operating temperature

## **Typical Characteristics**

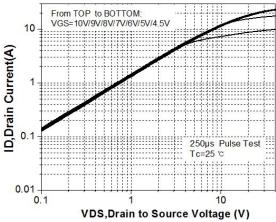


Figure 1. On-Region Characteristics

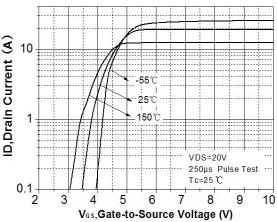


Figure 2. Transfer Characteristics

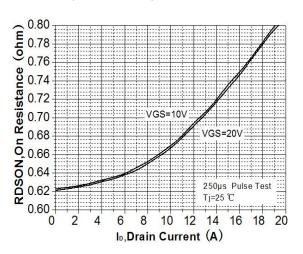


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

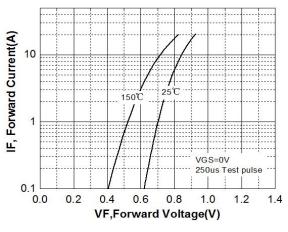


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

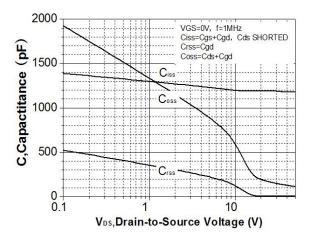


Figure 5. Capacitance Characteristics

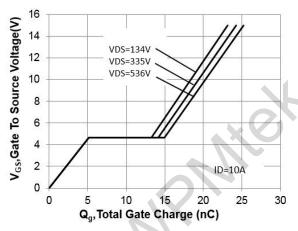
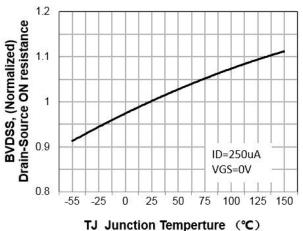


Figure 6. Gate Charge Characteristics



### Typical Characteristics (Continued)



RDSON, (Normalized)
Drain-Source Breakdown Voltage 2.7 2.4 2.1 1.8 1.5 1.2 0.9 ID=5A VGS=0V 0.6 0.3 25 50 75 100 125 150 TJ Junction Temperture (℃)

Figure 7. Breakdown Voltage Variation vs Temperature

100 100us Operate in This Area is Limited by RDSON b, Drain Current(A) 10 1ms DC 0.1 1.Tc=25 2.T=150°C 3. Single Pulse 0.01 1000 10 100

Figure 8. On-Resistance Variation vs Temperature

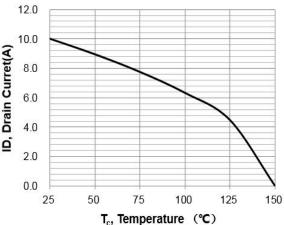


Figure 9. Maximum Safe Operating Area

Vos, Drain-to-Source Voltage(V)

Figure 10. Maximum Drain Current vs Case Temperature

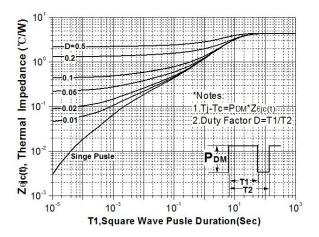
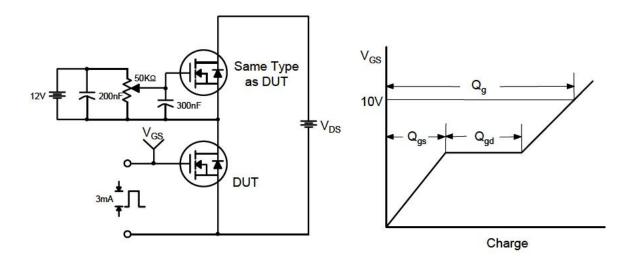


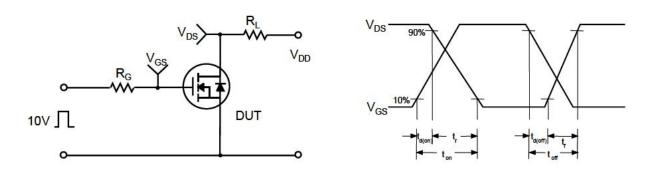
Figure 11. Transient Thermal Response Curve



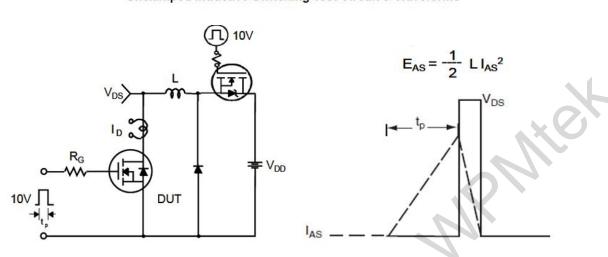
#### Gate Charge Test Circuit & Waveform



#### Resistive Switching Test Circuit & Waveforms

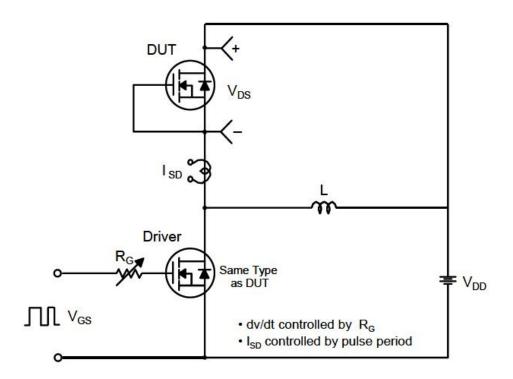


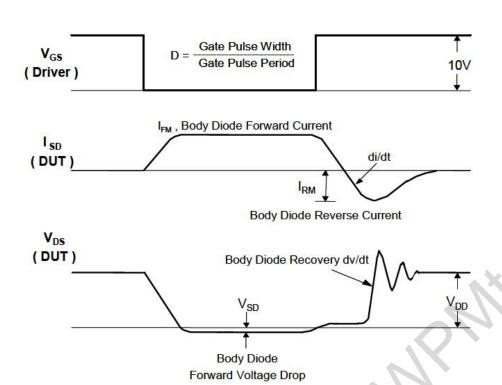
# **Unclamped Inductive Switching Test Circuit & Waveforms**





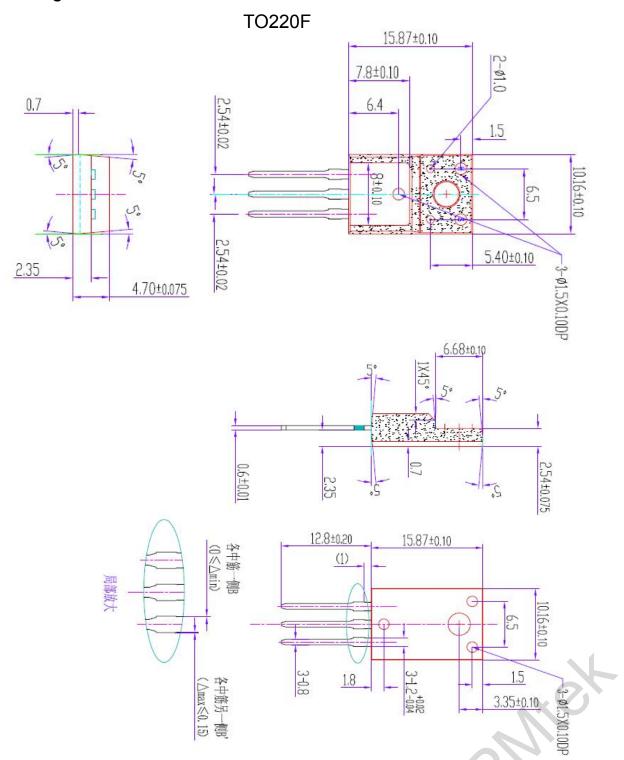
# Peak Diode Recovery dv/dt Test Circuit & Waveforms







# **Package Dimensions**



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